

Thick Film Chip Resistor Array

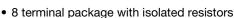


The CRA04P thick film resistor array is constructed on a high grade ceramic body with concave terminations. A small package enables the design of high density circuits. The single component reduces board space, component counts and assembly costs.

FEATURES









 Pure tin solder contacts on Ni barrier layer, provides compatibility with lead (Pb)-free and lead containing soldering processes

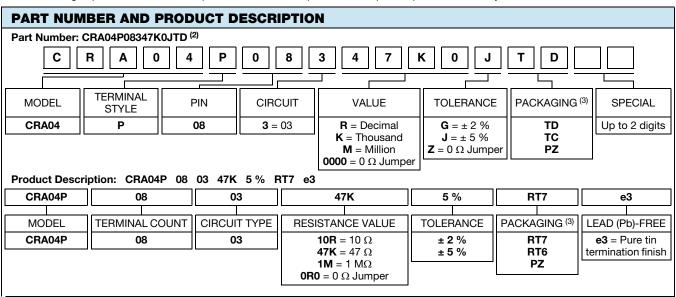
 Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

STANDARD ELECTRICAL SPECIFICATIONS								
MODEL	CIRCUIT	POWER RATING P _{70 °C} W	LIMITING ELEMENT VOLTAGE MAX. V≅	TEMPERATURE COEFFICIENT ± ppm/K	TOLERANCE ± %	RESISTANCE RANGE Ω	E-SERIES	
		0.063	50	100	2	10 to 1M	24	
CRA04P	03			200	5	1 to 1M	24	
		Zero-Ohm-Resistor: $R_{\text{max.}} = 50 \text{ m}\Omega$, $I_{\text{max.}} = 1 \text{ A}$						

TECHNICAL SPECIFICATIONS						
PARAMETER	UNIT	CRA04P				
Rated dissipation P ₇₀ ⁽¹⁾	W per element	0.063				
Limiting element voltage U _{max.} AC/DC	V	50				
Insulation voltage U _{ins} (1 min)	V	100				
Insulation resistance	Ω	> 109				
Category temperature range	°C	- 55 to + 155				

Note

(1) Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.



Notes

(2) Preferred way for ordering products is by use of the PART NUMBER.

(3) Please refer to the table PACKAGING, see next page.

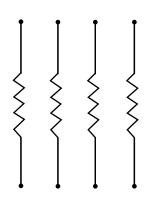




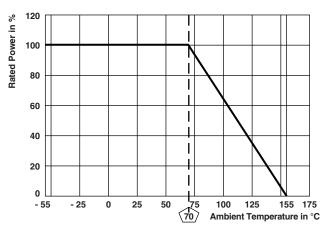
PACKAGING								
		DIAMETER	PITCH	PIECES/REEL	PACKAGING CODE			
MODEL	TAPE WIDTH				PAPER TAPE			
					PART NUMBER	PRODUCT DESCRIPTION		
		180 mm/7"	2 mm	10 000	TD	RT7		
CRA04P	8 mm	330 mm/13"	2 mm	20 000	TC	RT6		
		330 mm/13"	2 mm	50 000	PZ	PZ		

CIRCUIT

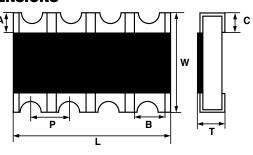
03 Circuit

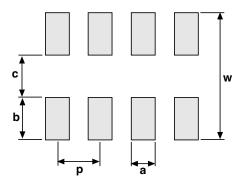


DERATING



DIMENSIONS





PIN	DIMENSIONS in millimeters						
NO#	L	Α	В	С	P _{NOM} .	Т	W
8	2.00	0.20	0.32	0.25	0.50	0.45	1.00
TOL.	± 0.20	± 0.10	± 0.10	± 0.15	-	± 0.10	± 0.10

SOLDER PAD DIMENSIONS in millimeters						
	С	w	р	а	b	
WAVE	0.5	1.5	0.5	0.32	0.5	



TEST PROCEDURES AND REQUIREMENTS									
EN 60115-1	IEC 60068-2 TEST	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR) (1)					
CLAUSE METHOD				STABILITY CLASS 2 OR BETTER					
			Stability for product type:	- 10 Ω to 1 MΩ					
			CRA04P	10 22 10 1 10122	1 Ω to 1 MΩ				
4.5	-	Resistance	-	± 2 %	± 5 %				
4.7	-	Voltage proof	$U = 1.4 \times U_{ins}$; 60 s	No flashover	or breakdown				
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ \(\leq 2 \times U_{\text{max.}}\); Duration according to style	± (0.5 % F	? + 0.05 Ω)				
4 17 0	E0 (Td)	Coldorability	Solder bath method; Sn60Pb40; non-activated flux; (235 ± 5) °C; (2 ± 0.2) s	• · · ·	95 % covered) e damage				
4.17.2	58 (Td)	Solderability	Solder bath method; Sn96.5Ag3Cu0.5; non-activated flux; (245 ± 5) °C; (3 ± 0.3) s	- ,	95 % covered) damage				
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K	± 200 ppm/K				
4.32	21 (U _{U3})	Shear (adhesion)	45 N	No visible	e damage				
4.33	21 (U _{U1})	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.25 \% R + 0.05 \Omega)$					
4.19	14 (Na)	Rapid change of temperature	30 min. at - 55 °C; 30 min at 125 °C 5 cycles 1000 cycles	± (0.5 % R + 0.05 Ω) ± (1 % R + 0.05 Ω)					
4.23	-	Dry heat	-	,	,				
4.23.2	2 (Ba)	Damp heat, cyclic	125 °C; 16 h						
4.23.3	30 (Db)	Cold	55 °C; ≥ 90 % RH; 24 h; 1 cycle						
4.23.4	1 (Aa)	Low air pressure	- 55 °C; 2 h	± (2 % R + 0.05 Ω)					
4.23.5	13 (M)	-	1 kPa; (25 ± 10) °C; 1 h						
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycle						
4.23.7	-	D.C. load	$U = \sqrt{P_{70} \times R}$						
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}}$ 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h		? + 0.1 Ω) ? + 0.1 Ω)				
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 ± 5) °C; (10 ± 1) s						
4.35	-	Flammability, needle flame test	IEC 60695-11-5; 10 s	No burning	g after 30 s				
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (1 % R + 0.05 Ω)					
4.25.3	-	Endurance at upper category temperature	155 °C; 1000 h	± (2 % R + 0.1 Ω)					
4.40	-	Electrostatic discharge (human body model)	IEC 61340-3-1; 3 positive and 3 negative discharges; ESD voltage according to style	± (1 % R + 0.05 Ω)					
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible	e damage				
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1; toothbrush	Marking legible, no visible damage					
4.22	6 (Fc)	Vibration, endurance by sweeping	$f = 10 \text{ Hz to } 2000 \text{ Hz; x, y, z} \le 1.5 \text{ mm;}$ $A \le 200 \text{ m/s}^2; 10 \text{ sweeps per axis}$	± (0.5 % R + 0.05 Ω)					
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R} \le 2 \times U_{\text{max.}}$ 0.1 s on; 2.5 s off; 1000 cycles	± (1 % R	+ 0.05 Ω)				
4.27	-	Single pulse high voltage overload, 10 µs/700 µs	$\hat{U} = 10 \times \sqrt{P_{70} \times R} \le 2 \times U_{\text{max.}}$ 10 pulses	± (1 % R	+ 0.05 Ω)				

Note

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.

⁽¹⁾ Figures are given for a single element.



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.